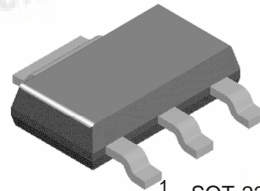




# SB29003

## High Voltage Transistor



1 SOT-223  
Marking: 5463003  
1.Base 2.Collector 3.Emitter

### Absolute Maximum Ratings $T_a = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Value	Units
$V_{CBO}$	Collector-Base Voltage	500	V
$V_{CEO}$	Collector-Emitter Voltage	400	V
$V_{EBO}$	Emitter-Base Voltage	6	V
$I_C$	Collector Current	300	mA
$P_C$	Collector Dissipation ( $T_C = 25^\circ\text{C}$ )	2	W
$T_J$	Junction Temperature	150	$^\circ\text{C}$
$T_{STG}$	Storage Temperature	-55 ~ 150	$^\circ\text{C}$

### Electrical Characteristics $T_C = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Conditions	Min.	Max	Units
$BV_{CBO}$	Collector-Base Breakdown Voltage	$I_C = 100\mu\text{A}$ , $I_B = 0$	500		V
$BV_{CER}$	Collector-Emitter Breakdown Voltage *	$I_C = 1\text{mA}$ , $I_B = 0$	400		V
$BV_{EBO}$	Emitter-Base Breakdown Voltage	$I_E = 100\mu\text{A}$ , $I_C = 0$	6		V
$I_{CBO}$	Collector Cut-off Current	$V_{CB} = 400\text{V}$ , $I_E = 0$		0.1	$\mu\text{A}$
$I_{CES}$	Collector Cut-off Current	$V_{CE} = 400\text{V}$ , $I_B = 0$		0.5	$\mu\text{A}$
$I_{EBO}$	Emitter Cut-off Current	$V_{EB} = 4\text{V}$ , $I_C = 0$		0.1	$\mu\text{A}$
$h_{FE}$	DC Current Gain *	$V_{CE} = 10\text{V}$ , $I_C = 1\text{mA}$ $V_{CE} = 10\text{V}$ , $I_C = 10\text{mA}$ $V_{CE} = 10\text{V}$ , $I_C = 50\text{mA}$ $V_{CE} = 10\text{V}$ , $I_C = 100\text{mA}$	40 50 45 40	200	
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage *	$I_C = 1\text{mA}$ , $I_B = 0.1\text{mA}$ $I_C = 10\text{mA}$ , $I_B = 1\text{mA}$ $I_C = 50\text{mA}$ , $I_B = 5\text{mA}$		0.4 0.5 0.75	V
$V_{BE(sat)}$	Base-Emitter Saturation Voltage *	$I_C = 10\text{mA}$ , $I_B = 1\text{mA}$		0.75	V
$C_{ob}$	Output Capacitance	$V_{CB} = 20\text{V}$ , $I_E = 0$ , $f = 1\text{MHz}$		7	pF

\* Pulse Test:  $PW \leq 300\mu\text{s}$ , Duty Cycle  $\leq 2\%$



## Typical Performance Characteristics

Figure 1. DC Current Gain

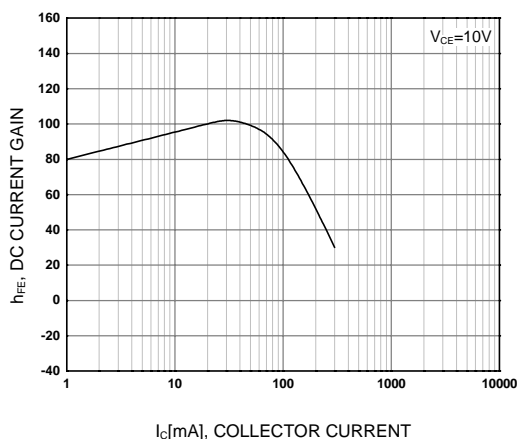


Figure 2. Capacitance

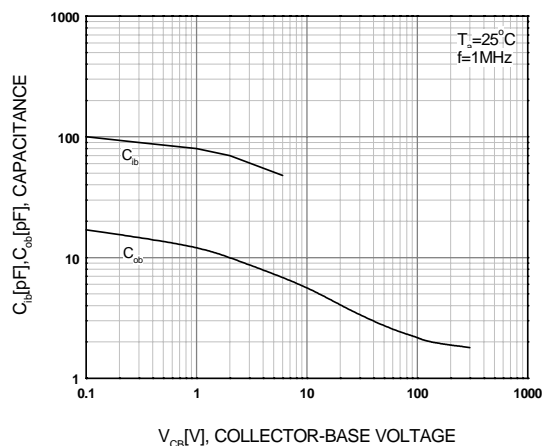


Figure 3. On Voltage

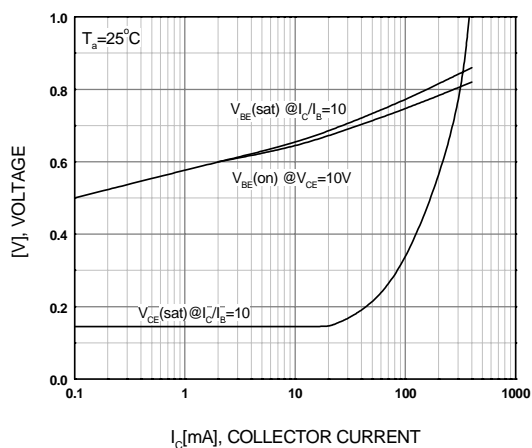


Figure 4. Collector Saturation Region

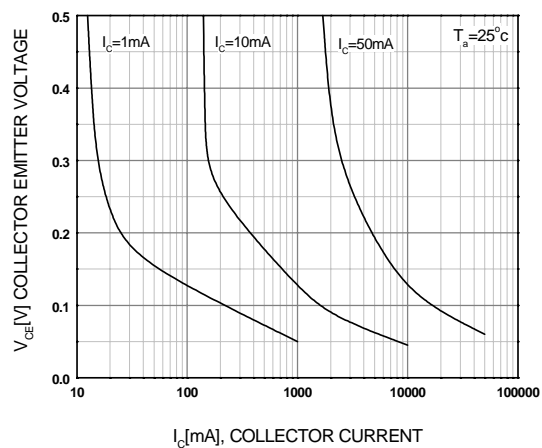
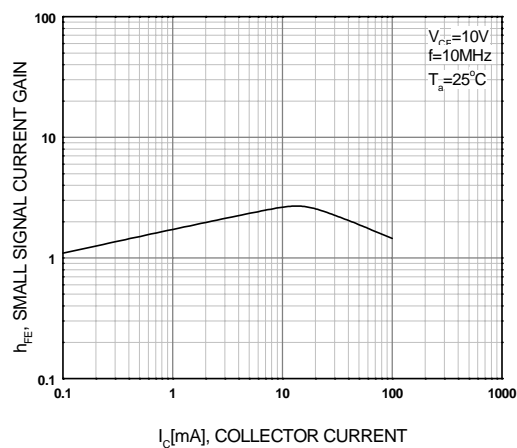
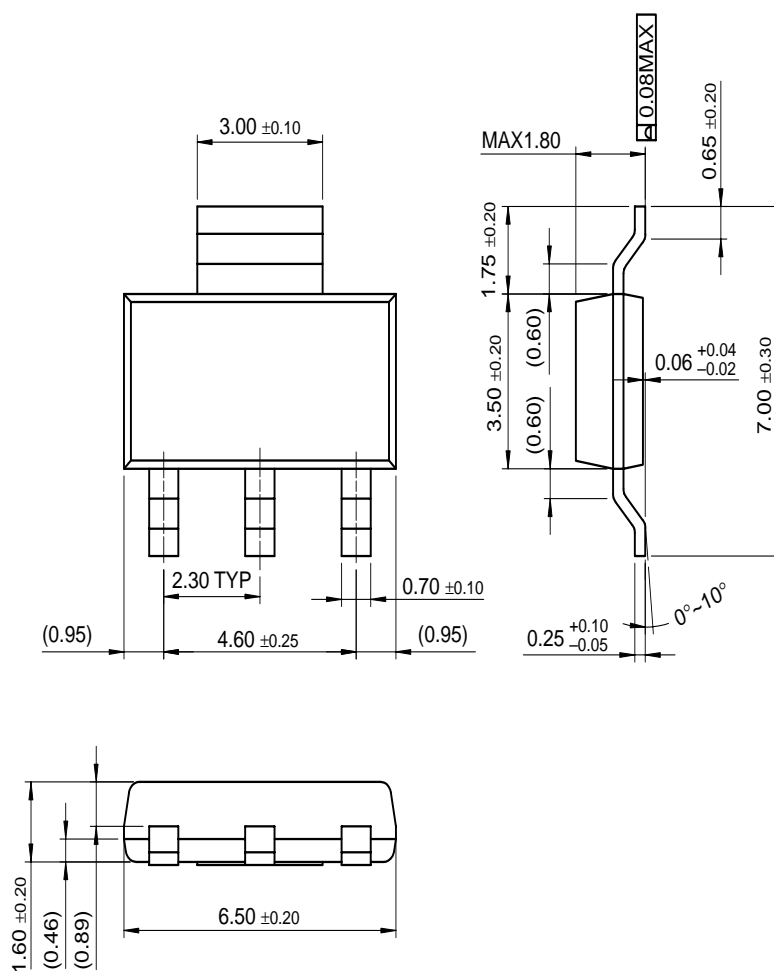


Figure 5. High Frequency Current Gain



# Mechanical Dimensions

## SOT-223



Dimensions in Millimeters

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CROSSVOLT™	GlobalOptoisolator™	MicroPak™	QFET®	SuperSOT™-8
DOMETM	GTO™	MICROWIRE™	QS™	SyncFET™
EcoSPARK™	HiSeC™	MSX™	QT Optoelectronics™	TinyLogic®
E <sup>2</sup> CMOSTM	I <sup>2</sup> C™	MSXPro™	Quiet Series™	TINYOPTO™
EnSigna™	i-Lo™	OCX™	RapidConfigure™	TruTranslation™
FACT™	ImpliedDisconnect™	OCXPro™	RapidConnect™	UHC™
FACT Quiet Series™		OPTOLOGIC®	μSerDes™	UltraFET®
Across the board. Around the world.™		OPTOPLANAR™	SILENT SWITCHER®	UniFET™
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Programmable Active Droop™		POP™	SPM™	

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